Attorney's Docket No.: 10559-857001 Client's Ref. No.: P17305

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Applicant: Sarah E. Kim et al.

Art Unit : 2814

Serial No.: 10/659,044

Examiner: Thao X Le

Filed

: September 9, 2003

Title

: Thick Metal Layer Integrated Process Flow To Improve Power Delivery and

Mechanical Buffering

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Attached to this facsimile communication cover sheet is an Amendment and Transmittal

day of June, 2005, to the United States Patent and Trademark

Office.

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6/05 Date: June /// 2005

Respectfully submitted,

Reg. No. 32,030

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